

PATENT ASSIGNMENT

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Jong Won LEE	12/12/2009
Yae Sil KIM	12/12/2009
Kyung Sik SONG	12/12/2009
Hyung Soo HAN	12/12/2009
Jung Hee JANG	12/12/2009
Chae Ha YANG	12/12/2009
Sun Ha LIM	12/12/2009

RECEIVING PARTY DATA

Name:	Hypoxi Co., Ltd.
Street Address:	320 St. Luke Bldg., Catholic University of Daegu, 3056-6
Internal Address:	Daemyung, 4-Dong, Nam-Gu
City:	Daegu
State/Country:	KOREA, DEMOCRATIC PEOPLE'S REPUBLIC OF
Postal Code:	750-718

Name:	Sun Mok Institute Education Foundation
Street Address:	225-1, Namsan 3-Dong, Jung-gu
City:	Daegu
State/Country:	KOREA, DEMOCRATIC PEOPLE'S REPUBLIC OF
Postal Code:	700-443

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12666969

CORRESPONDENCE DATA

Fax Number: (202)637-5910

501062078

PATENT
REEL: 023761 FRAME: 0117

CH \$40.00 12666969

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2026375600
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Correspondent Name: Celine Jimenez Crowson
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ATTORNEY DOCKET NUMBER:	36102-0012
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NAME OF SUBMITTER:	Kirk O. Hahn
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Total Attachments: 2 source=assignment#page1.tif source=assignment#page2.tif
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ASSIGNMENT

WHEREAS, I/We

LEE, Jong Won

of 102-505, Seohan Dure Mansion, 305-3, Beomeo 4-dong, Suseong-gu, Daegu 706-822, Republic of Korea

KIM, Yae Sil

of 102-505, Seohan Dure Mansion, 305-3, Beomeo 4-dong, Suseong-gu, Daegu 706-822, Republic of Korea

SONG, Kyung Sik

of 229-1106, Siji Cheonma Mansion, Sinmae-dong, Suseong-gu, Daegu, 706-750, Republic of Korea

HAN, Hyung Soo

of 6-305, Beomeo Woobang Apt., 671, Beomeo 1-dong, Suseong-gu, Daegu 706-737, Republic of Korea

JANG, Jung Hee

of 202-809, 2nd Daedeok Mansion, Bongdeok, 3-dong, Nam-gu, Daegu, 705-752, Republic of Korea

YANG, Chae Ha

of 715-6, Bongdeok-dong, Nam-gu, Daegu 750-020, Republic of Korea

LIM, Sun Ha

of 211-1508, wolseong Jungong APT., Wolseong 2-dong, Dalseo-gu, Daegu 704-782, Republic of Korea

have invented certain new and useful improvements in a **THERAPEUTIC/HEALTH CARE FOOD** for which we have executed an application for Letters Patent in the United States, **COMPOSITION COMPRISING STARCH OR DIETARY FIBER FROM GRAMINEAE PLANT FOR PREVENTION AND TREATMENT OF ISCHEMIC DISEASES AND DEGENERATIVE BRAIN DISEASES;**

AND WHEREAS,

HYPOXI CO., LTD (hereinafter "ASSIGNEE"), a Corporation, with its principal place of business at **#320, ST. LUKE BLDG., CATHOLIC, UNIVERSITY OF DAEGU, 3056-6, DAEMYUNG, 4-DONG, NAM-GU, DAEGU 750-718, KOREA;**

and

SUN MOK INSTITUTE EDUCATION FOUNDATION (hereinafter "ASSIGNEE"), a Corporation, with its principal place of business at **225-1, NAMSAN 3-DONG, JUNG-GU, DAEGU 700-443, KOREA**

desire to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights

of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, successors, legal representatives and assigns, in accordance with the terms of this instrument.

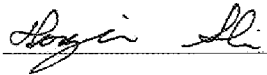
AND WE DO HEREBY sell, assign, transfer, and convey to ASSIGNEE, his successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the said Letters Patent before or after issuance.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 12th day of December, 2009 .

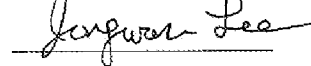
WITNESS:

SHIN, Dong-In

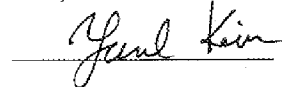


INVENTORS

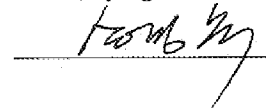
LEE, Jong Won



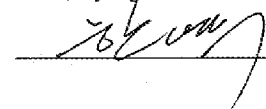
KIM, Yae Sil



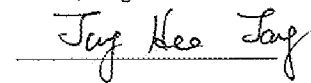
SONG, Kyung Sik



HAN, Hyung Soo



JANG, Jung Hee



YANG, Chae Ha



LIM, Sun Ha

